5. Pinning information

Table 2. I	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	К	cathode [1]		
3	A2	anode 2		
mb	К	mounting base; connected to cathode		K sym125

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
BYQ28ED-200	TO252	BYQ28ED-200, 118	Reel	2500	TO252N	14-Nov-2016	

7. Marking

Table 4. Marking codes						
Type number	Marking codes					
BYQ28ED-200	Q28E20					

8. Limiting values

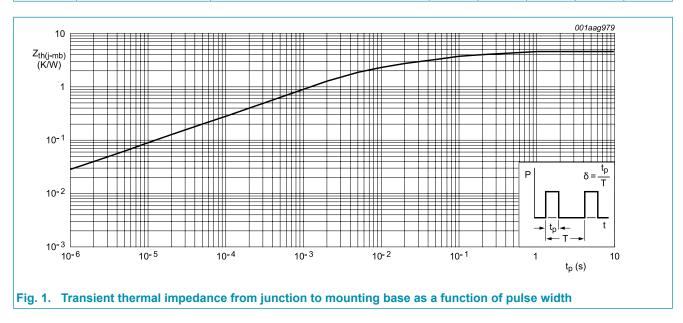
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		200	V
V_{RWM}	crest working reverse voltage		200	V
V _R	reverse voltage	δ = 1.0; square-wave pulse;	200	V
I _{O(AV)}	average output current	δ = 0.5; square-wave pulse; T _{mb} ≤ 119 °C; both diodes conducting; Fig. 6; Fig. 7	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 119 °C; square-wave pulse; per diode	10	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; sine-wave pulse; per diode; Fig. 3	50	А
	forward current	t_p = 8.3 ms; sine-wave pulse; per diode	55	А
I _{RM}	peak reverse recovery current	$δ = 0.001; t_p = 2 μs$	0.2	A
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs	0.2	A
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C
Electrosta	tic discharge			
V_{ESD}	electrostatic discharge voltage	all pins; human body model; C = 250 pF; R = 1.5 k Ω	8	kV

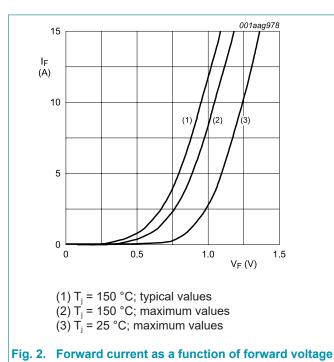
9. Thermal characteristics

able 6. In	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to	with heatsink compound; both diodes conducting	-	-	3	K/W
	mounting base	with heatsink compound; per diode; Fig 1	-	-	4.5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	·				
V _F	forward voltage	I _F = 5 A; T _j = 150 °C; <u>Fig. 2</u>	-	0.8	0.895	V
		I _F = 5 A; T _j = 25 °C; <u>Fig. 2</u>	-	0.95	1.1	V
		I _F = 10 A; T _j = 25 °C; <u>Fig. 2</u>	-	1.1	1.25	V
I _R	reverse current	V _R = 200 V; T _j = 25 °C	-	2	10	μA
		V _R = 200 V; T _j = 100 °C	-	0.1	0.2	mA
Dynamic (characteristics					
Q _r	recovered charge	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 20 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 4$	-	4	9	nC
t _{rr}	reverse recovery time	ramp recovery; I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/µs; T _j = 25 °C; <u>Fig. 4</u>	-	15	25	ns
		step recovery; when switched from $I_F = 0.5 A$ to $I_R = 1 A$; measured at $I_R = 0.25 A$	-	10	20	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 4}$	-	0.5	0.7	A
V_{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 10 A/μs; T _i = 25 °C; <u>Fig. 5</u>	-	1	-	V



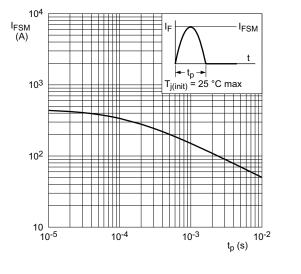
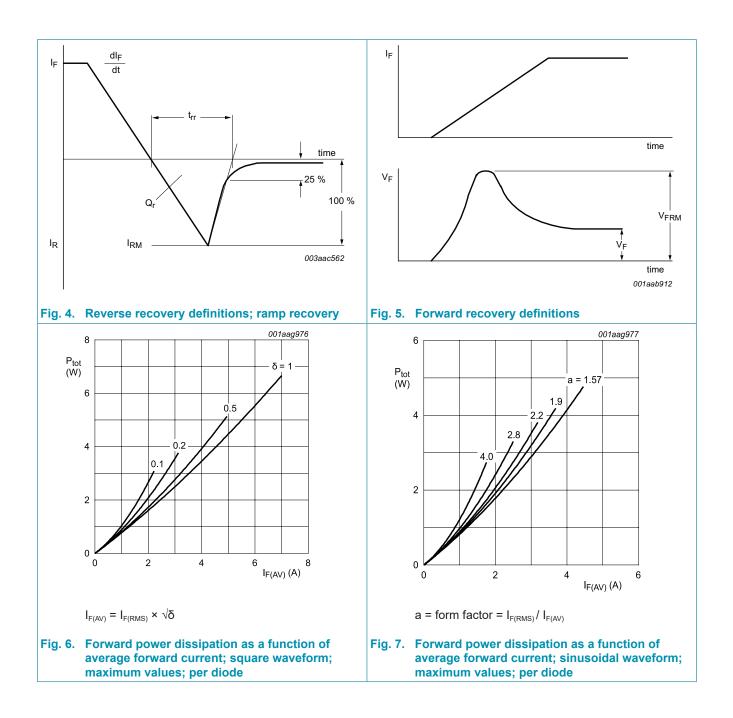


Fig. 3. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

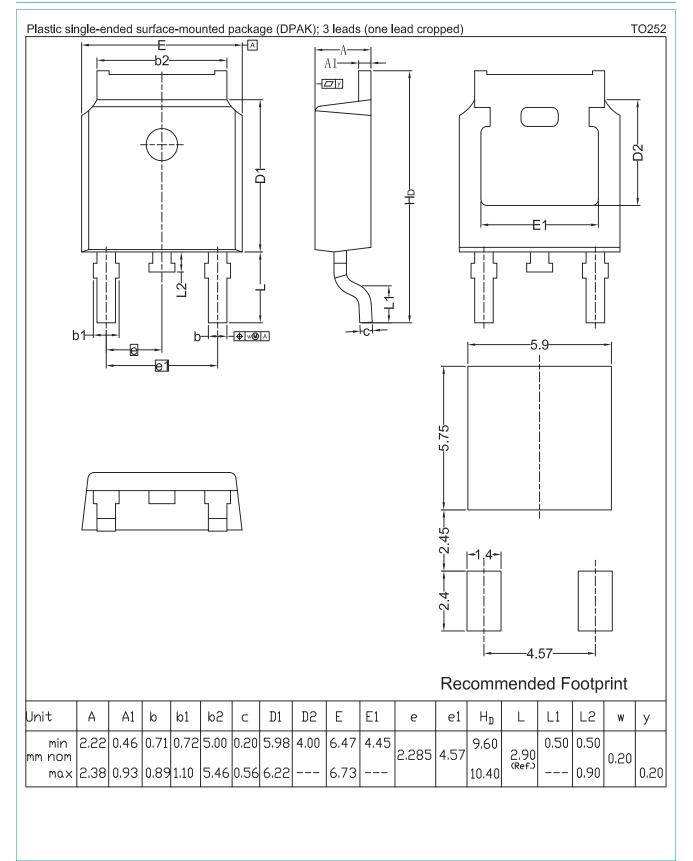
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11. Package outline



BYQ28ED-200 Product data sheet

12. Revision history

Table 8. Revision histor	ry				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BYQ28ED-200 v.7	20190923	Product data sheet	-	BYQ28ED-200 v.6	
Modifications:	 Update Marking code. Update ordering information	۱.			
BYQ28ED-200 v.6	20181218	Product data sheet	-	BYQ28ED-200 v.5	
Modifications: Ad	d IFSM figure.			·	
BYQ28ED-200 v.5	20180224	Product data sheet	-	BYQ28_SER_E_ED_4	
Modifications: Ch	ange from NXP version to We	En version			
BYQ28_SER_E_ED_4	20071205	Product data sheet	-	BYQ28E_SERIES_3	
 Modifications: The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Limiting values table: some parameter descriptions amended to conform to latest standards; IFRM conditions amended; VESD row added. Characteristics: Qrr changed to Qr 'recovered charge'; trr1 and trr2 changed to trr with 'ramp recovery' and 'step recovery' added to conditions. 					
BYQ28E_SERIES_3	19981001	Product specification	-	BYQ28E_SERIES_2	
BYQ28E_SERIES_2	19980701	Product specification	-	BYQ28E_SERIES_1; BYQ28EB_SERIES_1	
BYQ28E_SERIES_1; BYQ28EB_SERIES_1	19960801	Product specification	-	-	

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13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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